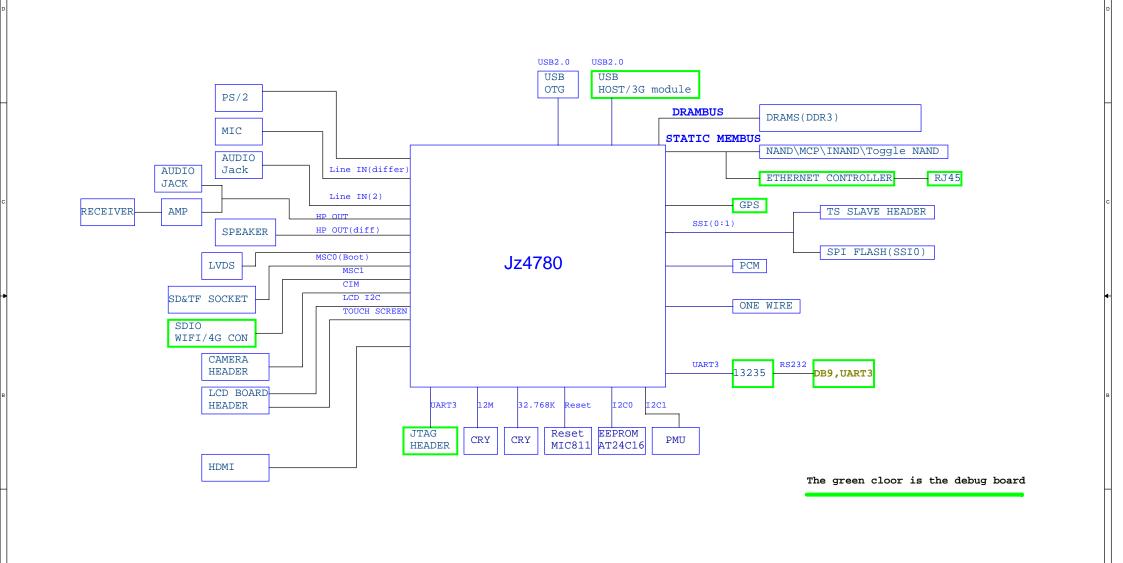
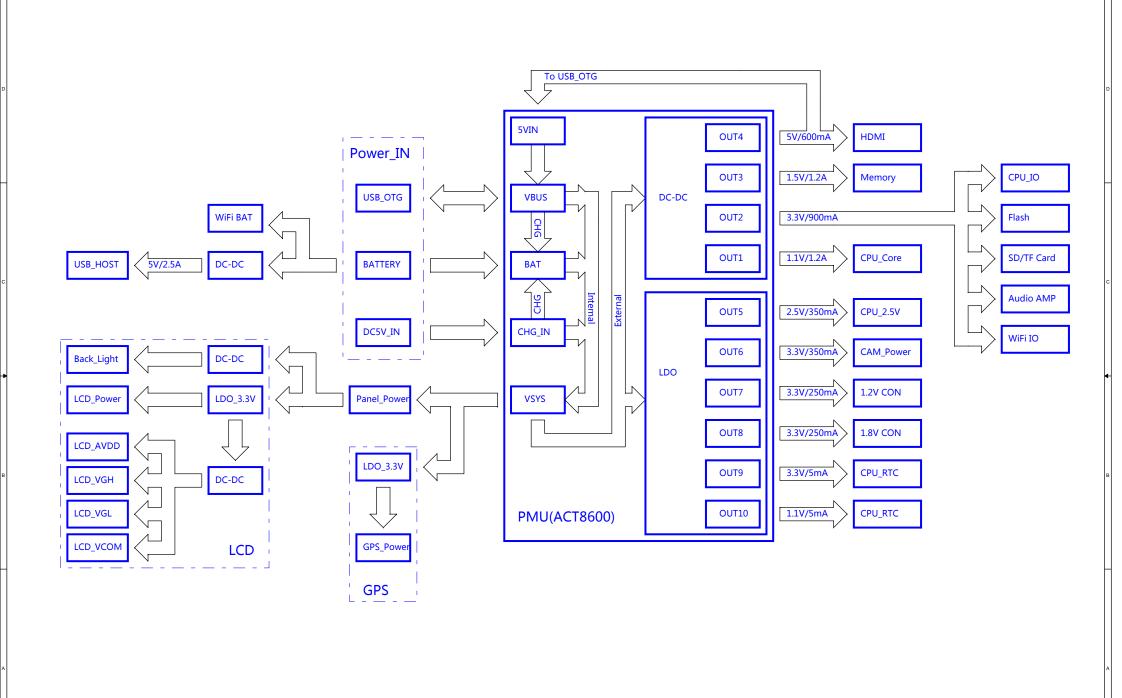


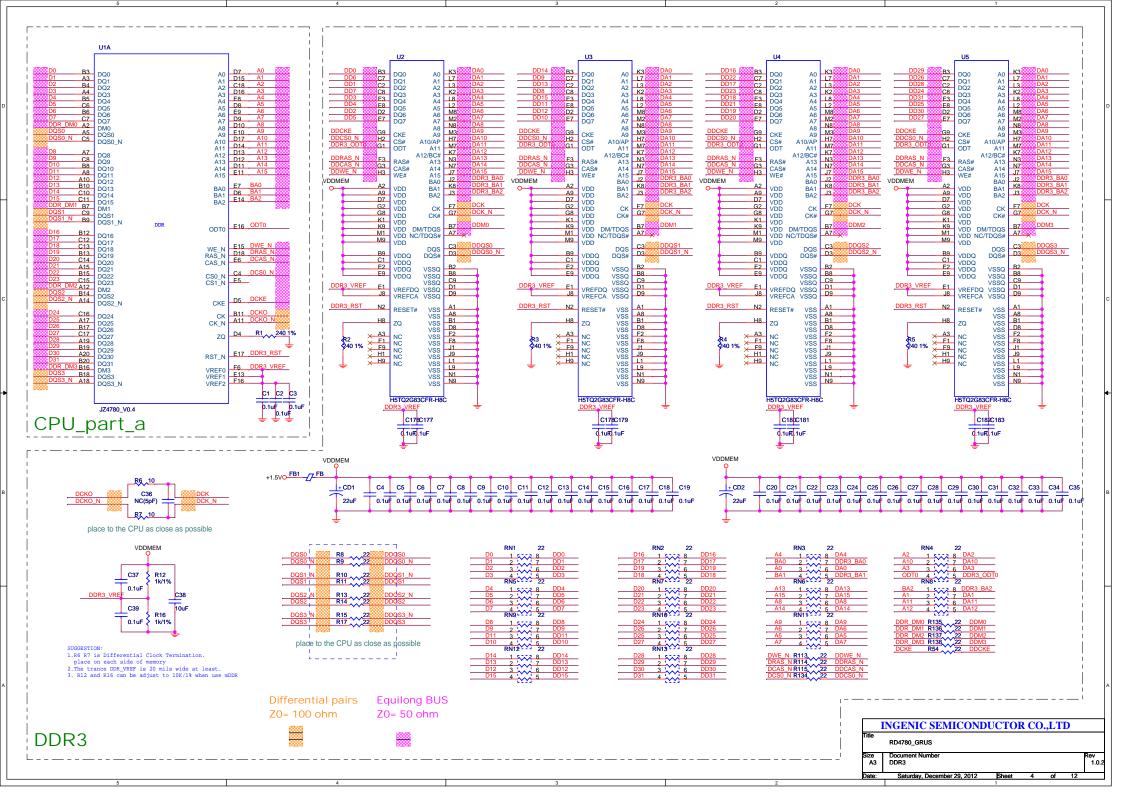
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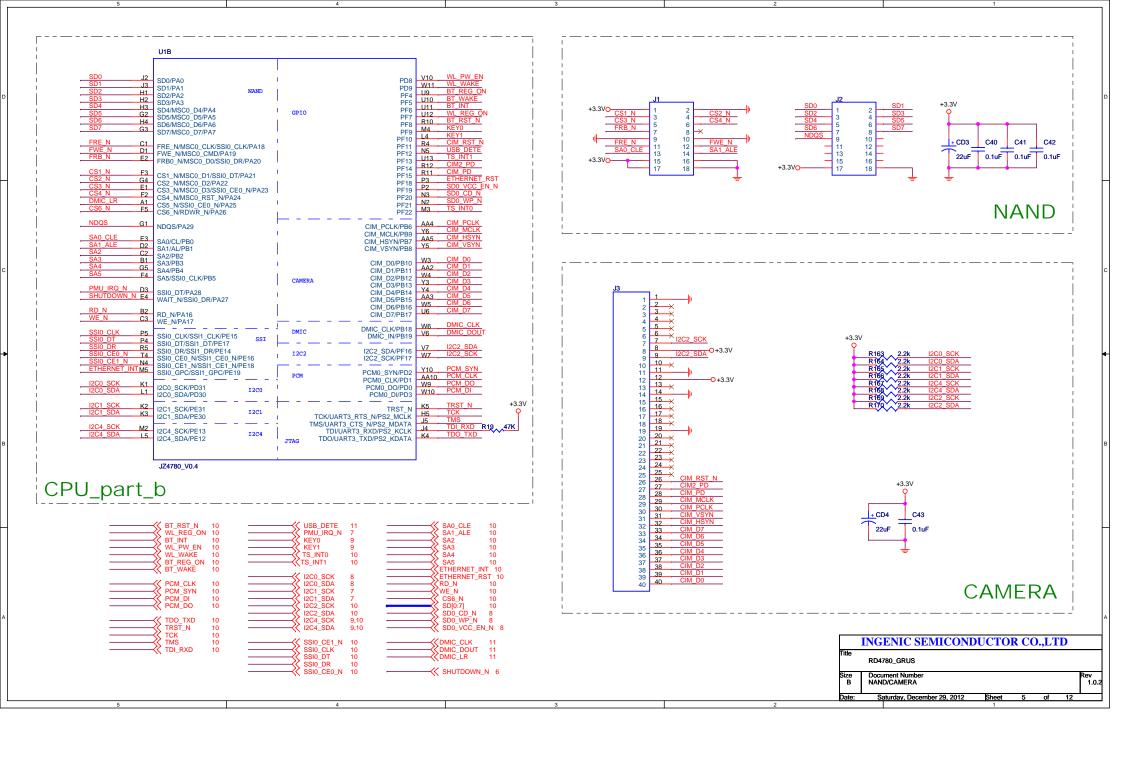
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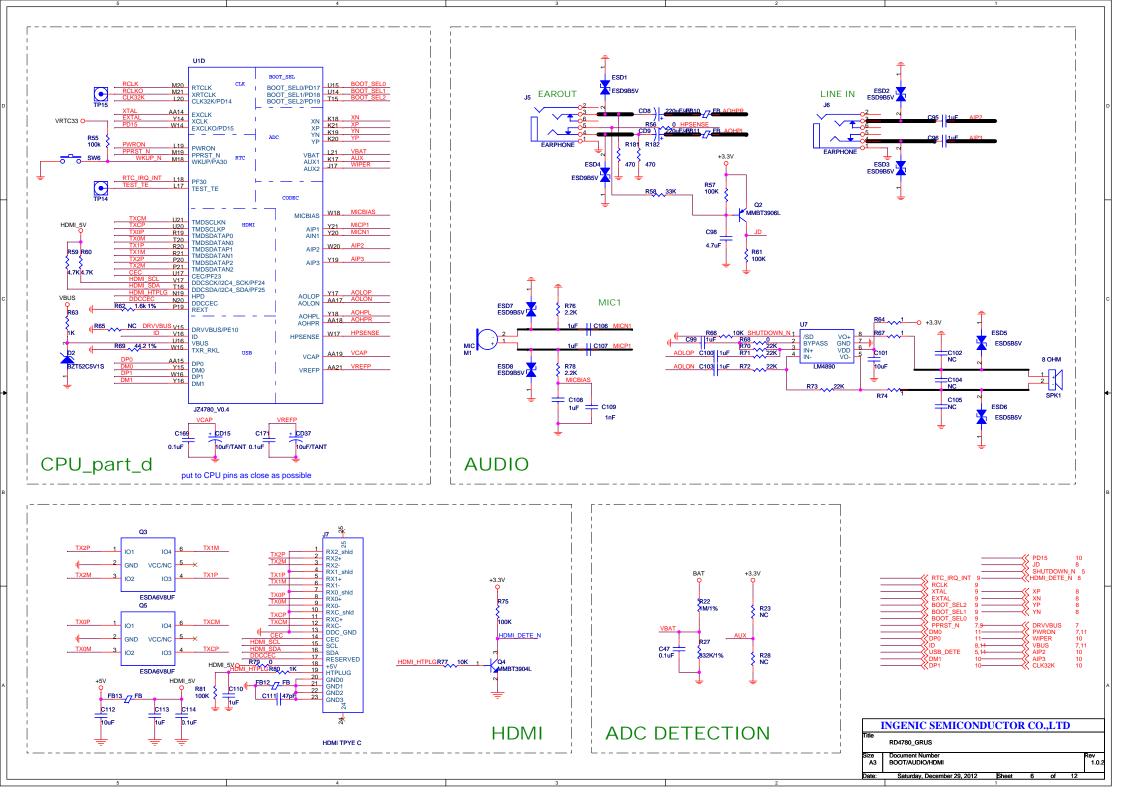
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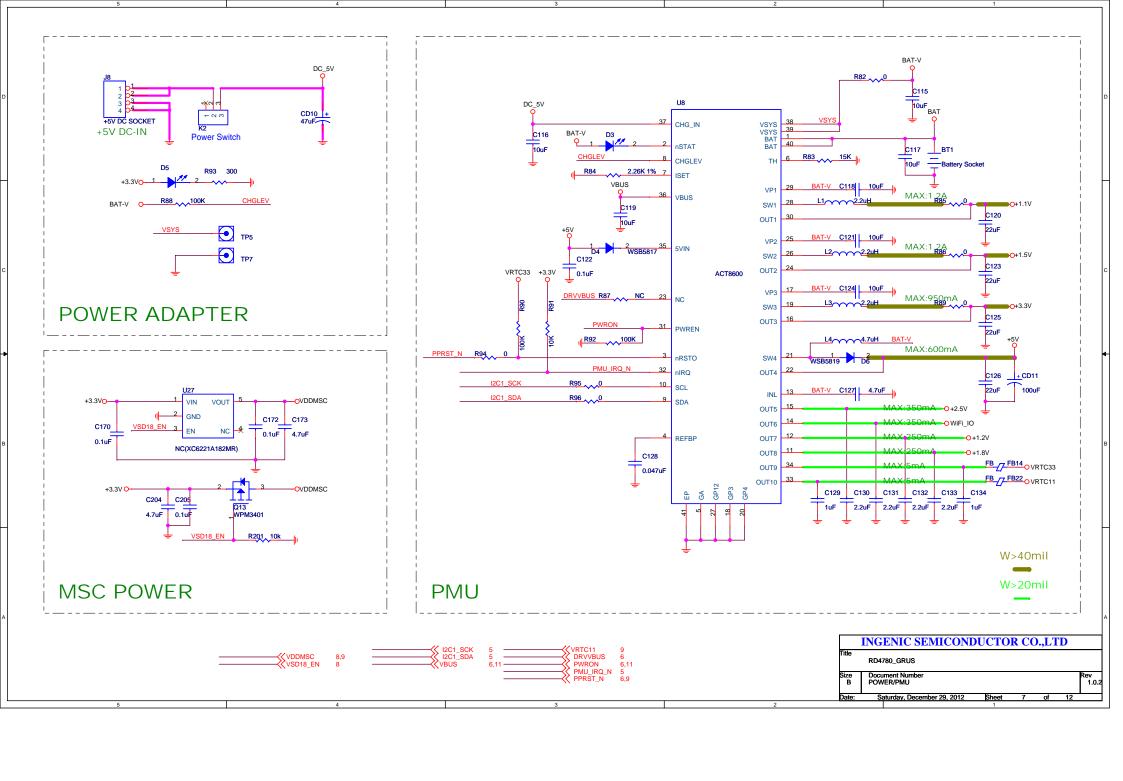


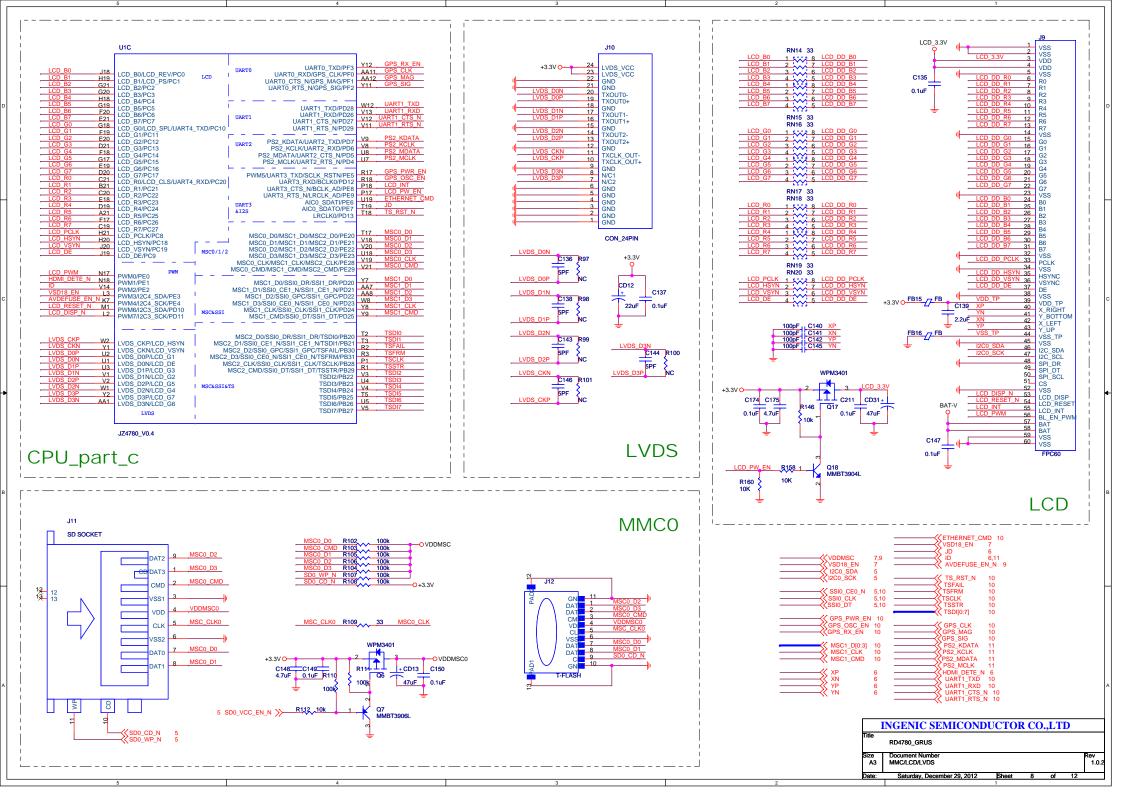


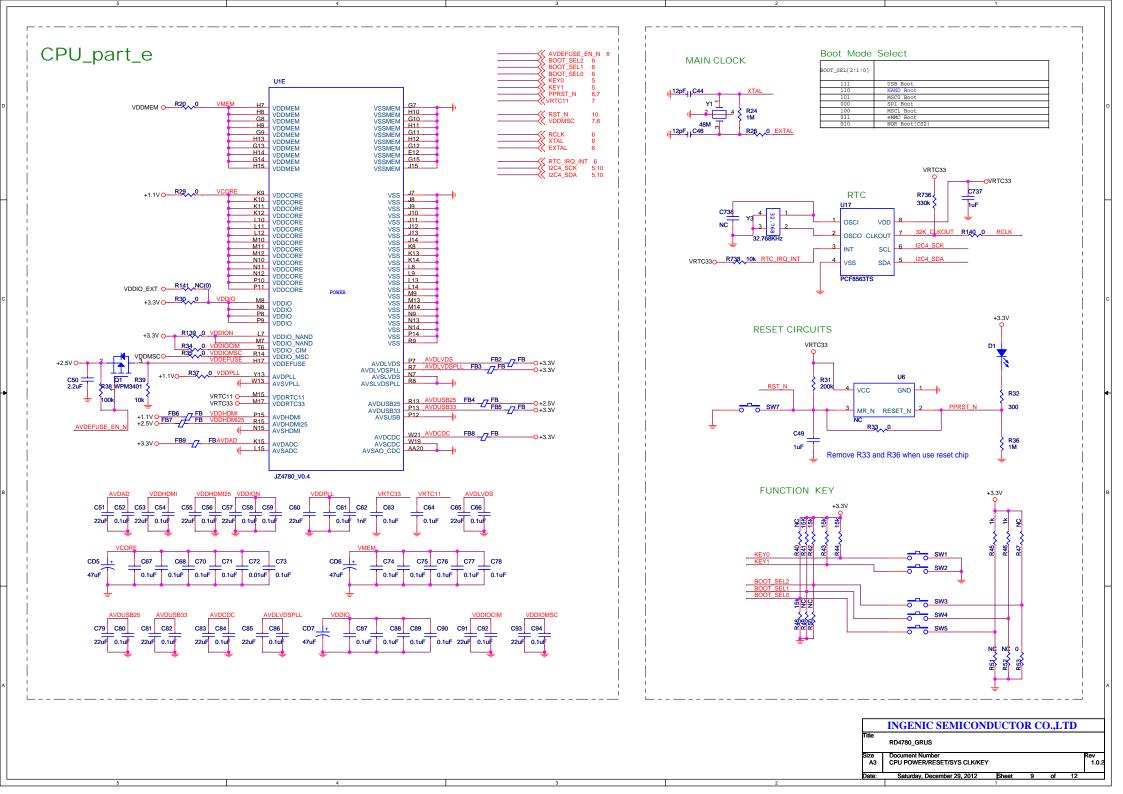


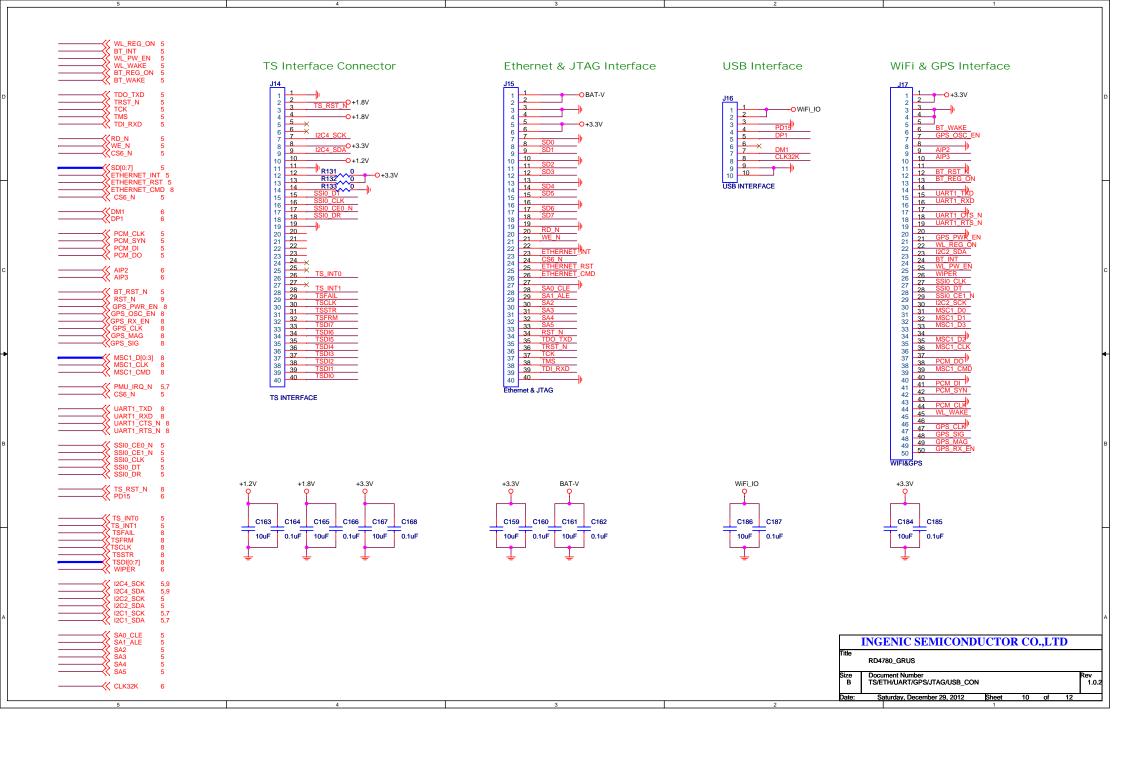


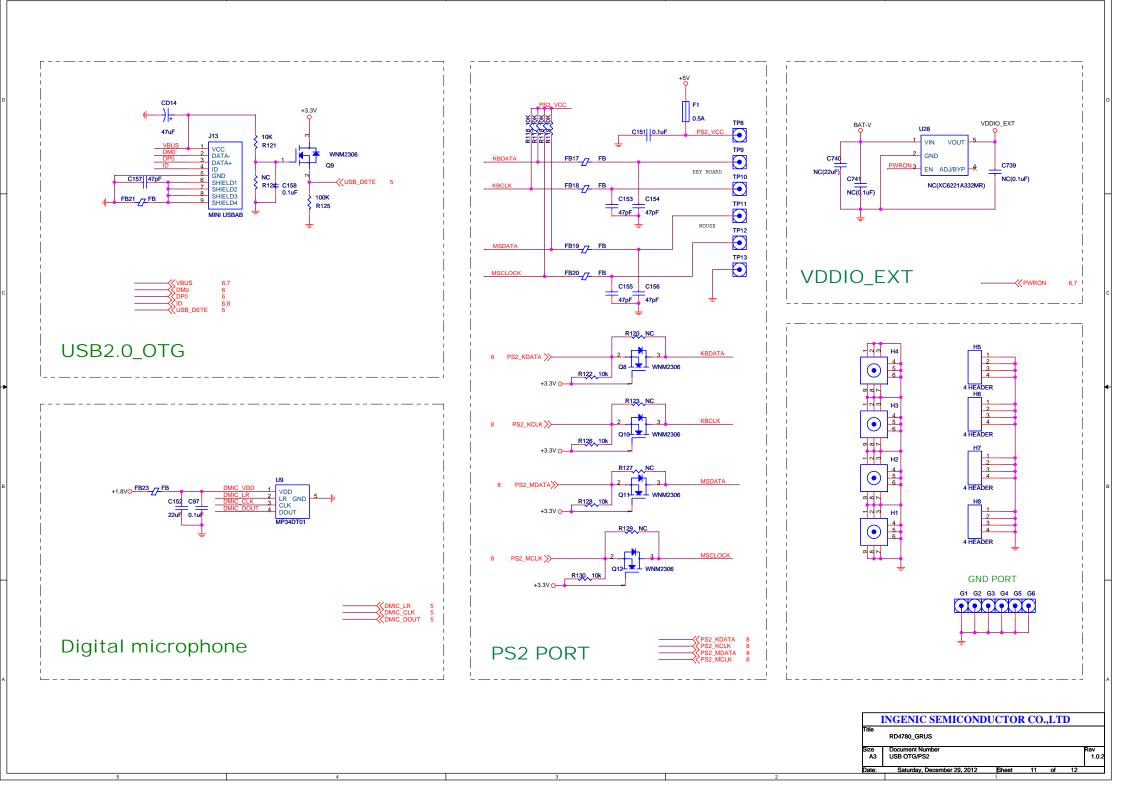












Data	Revision	Change
Aug 28 2012	Rev1.0	1. First Revision
Dec 29 2012	Rev1.0.2	 PAGE05: Delete R18 and connect SHUTDOWN_N to CPU PIN E4. PAGE06: Change the footprint of Audio connector J5 & J6 PAGE06: Change the footprint of D2. PAGE07: Change OUT2 to 1.5V and OUT3 to 3.3V. Change the OUT1,OUT2,OUT3 net to the back of resisters. PAGE07: Change MSC power chip U27 to XC6221A182MR and NC PAGE08: Change the schematic and PCB package of J11. PAGE09: Change R736 from 10K to 330K to reduce hibernate current. PAGE09: Change R31 from 10K to 200K, R36 from 100K to 1M, C49 from 0805 4.7uF to 0603 1uF, in order to reduce hibernate current.
		UbU3 1UF, in order to reduce hipernate current.

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